Features

- Single Voltage Operation
 - 5V Read
 - 5V Reprogramming
- Fast Read Access Time 90 ns
- Internal Program Control and Timer
- **16K Bytes Boot Block With Lockout**
- Fast Erase Cycle Time 10 seconds
- Byte-By-Byte Programming 10 µs/Byte Typical
- Hardware Data Protection
- **DATA** Polling For End Of Program Detection
- Low Power Dissipation
 - 50 mA Active Current
 - 100 µA CMOS Standby Current
- Typical 10,000 Write Cycles

Pin Configurations

Description

The AT49F080(T) is a 5-volt only in-system Flash Memory device. Its 8-megabits of memory is organized as 1,024,576 words by 8-bits. Manufactured with Atmel's advanced nonvolatile CMOS technology, the device offers access times to 90 ns with power dissipation of just 275 mW over the commercial temperature range. When the device is deselected, the CMOS standby current is less than 100 µA.

The device contains a user-enabled "boot block" protection feature. Two versions of the feature are available: the AT49F080 locates the boot block at lowest order addresses ("bottom boot"); the AT49F080T locates it at highest order addresses ("top (continued) boot").

5	
Pin Name	Function
A0 - A19	Addresses
CE	Chip Enable
ŌĒ	Output Enable
WE	Write Enable
RESET	Reset
RDY/BUSY	Ready/Busy Output
I/O0 - I/O7	Data Inputs/Outputs
NC	No Connect



____ A2 21 🗖 A3

NC 🗆	1	4	14		VCC	;
RESET 🖂	2	4	13		CE	
A11 🗔	3	4	12		A12	
A10	4	4	11		A13	
A9 🗖	5	4	10		A14	
A8 🗔	6	:	39		A15	
A7 🔄	7	:	38		A16	
A6 🗌	8	:	37		A17	
A5 🗔	9	:	36		A18	
A4 🗔	10	:	35		A19	
NC 🗆	11	3	34		NC	
NC 🗆	12	:	33		NC	
A3 🗔	13	:	32		NC	
A2 🔄	14	:	31		NC	
A1	15	3	30		WE	
A0 🗔	16	2	29		ŌĒ	
I/O0 🗀	17	2	28		RDY	//BUSY
I/01	18	2	27		I/07	
I/O2	19	2	26		I/O6	
I/O3 🗔	20	2	25		I/O5	
GND 🗀	21	2	24		I/O4	
GND 🚞	22	2	23		VCC	;
CB	GΑ	Tor	۰	Vi	e۱۸	,
00	0/1	101		• 1	0	
1	2 3	4	5		6	7

SOIC

A	A5 A8 A11 NC A12 A15 A17
В	
С	O O O O O O O O A6 A9 RST CE A14 A16 A19
D	
E	
F	A1 1/00 1/02 GND 1/05 RV/BY WE





8-Megabit (1M x 8) 5-volt Only **Flash Memory**

AT49F080 AT49F080T

Rev. 0584C-10/98

Downloaded from Elcodis.com electronic components distributor

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To allow for simple in-system reprogrammability, the AT49F080(T) does not require high input voltages for programming. 5-volt-only commands determine the read and programming operation of the device. Reading data out of the device is similar to reading from an EPROM. Reprogramming the AT49F080(T) is performed by erasing the entire 8 megabits of memory and then programming on a byte-by-byte basis. The typical byte programming time is a fast 10 μ s. The end of a program cycle can be optionally detected by the DATA polling feature. Once the end of a byte program cycle has been detected, a new access for a read or program can begin. The typical number of program and erase cycles is in excess of 10,000 cycles

The optional 16K bytes boot block section includes a reprogramming write lock out feature to provide data integrity. The boot sector is designed to contain user secure code, and when the feature is enabled, the boot sector is permanently protected from being reprogrammed.

Block Diagram



Device Operation

READ: The AT49F080(T) is accessed like an EPROM. When \overline{CE} and \overline{OE} are low and \overline{WE} is high, the data stored at the memory location determined by the address pins is asserted on the outputs. The outputs are put in the high impedance state whenever \overline{CE} or \overline{OE} is high. This dualline control gives designers flexibility in preventing bus contention.

ERASURE: Before a byte can be reprogrammed, the 1024K bytes memory array (or 1008K bytes if the boot block featured is used) must be erased. The erased state of the memory bits is a logical "1". The entire device can be erased at one time by using a 6-byte software code. The software chip erase code consists of 6-byte load commands to specific address locations with a specific data pattern (please refer to the Chip Erase Cycle Waveforms).

After the software chip erase has been initiated, the device will internally time the erase operation so that no external clocks are required. The maximum time needed to erase the whole chip is t_{EC} . If the boot block lockout feature has been enabled, the data in the boot sector will not be erased.

BYTE PROGRAMMING: Once the memory array is erased, the device is programmed (to a logical "0") on a

AT49F080(T)

byte-by-byte basis. Please note that a data "0" cannot be programmed back to a "1"; only erase operations can convert "0"s to "1"s. Programming is accomplished via the internal device command register and is a 4 bus cycle operation (please refer to the Command Definitions table). The device will automatically generate the required internal program pulses.

The program cycle has addresses latched on the falling edge of WE or \overline{CE} , whichever occurs last, and the data latched on the rising edge of WE or \overline{CE} , whichever occurs first. Programming is completed after the specified t_{BP} cycle time. The DATA polling feature may also be used to indicate the end of a program cycle.

BOOT BLOCK PROGRAMMING LOCKOUT: The device has one designated block that has a programming lockout feature. This feature prevents programming of data in the designated block once the feature has been enabled. The size of the block is 16K bytes. This block, referred to as the boot block, can contain secure code that is used to bring up the system. Enabling the lockout feature will allow the boot code to stay in the device while data in the rest of the device is updated. This feature does not have to be activated; the boot block's usage as a write protected region is optional to the user. The address range of the AT49F080 boot block is 00000H to 03FFFH while the address range of the AT49F080T boot block is FC000H to FFFFFH.

To activate the lockout feature, a series of six program commands to specific addresses with specific data must be performed. Please refer to the Command Definitions table.

BOOT BLOCK LOCKOUT DETECTION: A software method is available to determine if programming of the boot block section is locked out. When the device is in the software product identification mode (see Software Product Identification Entry and Exit sections) a read from address location 00002H will show if programming the boot block is locked out for the AT49F080, and a read from address location F3002H will show if programming the boot block is locked out for the AT49F080T. If the data on I/O0 is low, the boot block can be programmed; if the data on I/O0 is high, the program lockout feature has been activated and the block cannot be programmed. The software product identification exit code should be used to return to standard operation.

BOOT BLOCK PROGRAMMING LOCKOUT OVER-RIDE: The user can override the boot block programming lockout by taking the RESET pin to $12V \pm 0.5V$. By doing this, protected boot block data can be altered through a chip erase, or byte programming. When the RESET pin is brought back to TTL levels, the boot block programming lockout feature is again active.

PRODUCT IDENTIFICATION: The product identification mode identifies the device and manufacturer as Atmel. It may be accessed by hardware or software operation. The hardware operation mode can be used by an external programmer to identify the correct programming algorithm for the Atmel product.

For details, see Operating Modes (for hardware operation) or Software Product Identification. The manufacturer and device code is the same for both modes.

DATA POLLING: The AT49F080(T) features DATA polling to indicate the end of a program cycle. During a program cycle an attempted read of the last byte loaded will result in the complement of the loaded data on I/O7. Once the program cycle has been completed, true data is valid

on all outputs and the next cycle may begin. DATA polling may begin at any time during the program cycle.

TOGGLE BIT: In addition to DATA polling, the AT49F080(T) provides another method for determining the end of a program or erase cycle. During a program or erase operation, successive attempts to read data from the device will result in I/O6 toggling between one and zero. Once the program cycle has completed, I/O6 will stop toggling and valid data will be read. Examining the toggle bit may begin at any time during a program cycle.

RDY/BUSY: An open drain READY/BUSY output pin provides another method of detecting the end of a program or erase operation. RDY/BUSY is actively pulled low during the internal program and erase cycles and is released at the completion of the cycle. The open drain connection allows for OR - tying of several devices to the same RDY/BUSY line.

RESET: A RESET input pin is provided to ease some system applications. When RESET is at a logic high level, the device is in its standard operating mode. A low level on the RESET input halts the present device operation and puts the outputs of the device in a high impedance state. If the RESET pin makes a high to low transition during a program or erase operation, the operation may not be successfully completed and the operation will have to be repeated after a high level is applied to the RESET pin. When a high level is reasserted on the RESET pin, the device returns to the read or standby mode, depending upon the state of the control inputs. By applying a $12V \pm 0.5V$ input signal to the RESET pin, the boot block array can be reprogrammed even if the boot block lockout feature has been enabled (see Boot Block Programming Lockout Override section).

HARDWARE DATA PROTECTION: Hardware features protect against inadvertent programs to the AT49F080(T) in the following ways: (a) V_{CC} sense: if V_{CC} is below 3.8V (typical), the program function is inhibited. (b) Program inhibit: holding any one of \overline{OE} low, \overline{CE} high or \overline{WE} high inhibits program cycles. (c) Noise filter: pulses of less than 15 ns (typical) on the \overline{WE} or \overline{CE} inputs will not initiate a program cycle.



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Command Definition (in Hex)

Command	Bus	1st l Cy	Bus cle	2nd Cy	Bus cle	3rd Cy	Bus cle	4th Cy	Bus cle	5th Cy	Bus cle	6th Cy	Bus cle
Sequence	Cycles	Addr	Data	Addr	Data	Addr	Data	Addr	Data	Addr	Data	Addr	Data
Read	1	Addr	D _{OUT}										
Chip Erase	6	5555	AA	2AAA	55	5555	80	5555	AA	2AAA	55	5555	10
Byte Program	4	5555	AA	2AAA	55	5555	A0	Addr	D _{IN}				
Boot Block Lockout ⁽¹⁾	6	5555	AA	2AAA	55	5555	80	5555	AA	2AAA	55	5555	40
Product ID Entry	3	5555	AA	2AAA	55	5555	90						
Product ID Exit ⁽²⁾	3	5555	AA	2AAA	55	5555	F0						
Product ID Exit ⁽²⁾	1	XXXX	F0										

Notes: 1. The 16K byte boot sector has the address range 00000H to 03FFFH for the AT49F080 and FC000H to FFFFH for the AT49F080T.

2. Either one of the Product ID Exit commands can be used.

Absolute Maximum Ratings*

Temperature Under Bias55°C to +125°C
Storage Temperature65°C to +150°C
All Input Voltages (including NC Pins) with Respect to Ground0.6V to +6.25V
All Output Voltages with Respect to Ground0.6V to $\rm V_{\rm CC}$ + 0.6V
Voltage on $\overline{\text{OE}}$ with Respect to Ground0.6V to +13.5V

*NOTICE: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

AT49F080(T)

DC and AC Operating Range

		AT49F080(T)-90	AT49F080(T)-12	AT49F080(T)-15
Operating	Com.	0°C - 70°C	0°C - 70°C	0°C - 70°C
Temperature (Case)	Ind.	-40°C - 85°C	-40°C - 85°C	-40°C - 85°C
V _{CC} Power Supply		5V ± 10%	5V ± 10%	$5V\pm10\%$

Operating Modes

Mode	CE	OE	WE	RESET	Ai	I/O	RDY/BUSY
Read	V _{IL}	V _{IL}	V _{IH}	V _{IH}	Ai	D _{OUT}	V _{OH}
Program ⁽²⁾	V _{IL}	V _{IH}	V _{IL}	V _{IH}	Ai	D _{IN}	V _{OL}
Standby/Write Inhibit	V _{IH}	X ⁽¹⁾	х	V _{IH}	х	High Z	V _{OH}
Program Inhibit	Х	х	V _{IH}	V _{IH}			V _{OH}
Program Inhibit	Х	V _{IL}	Х	V _{IH}			V _{OH}
Output Disable	Х	V _{IH}	Х	V _{IH}		High Z	V _{OH}
RESET	Х	х	Х	V _{IL}	Х	High Z	
Product Identificatio	'n						
Llandurana	V _{IL}	V _{IL}	V _{IH}	V _{IH}	A1 - A19 = V_{IL} , A9 = V_{H} , ⁽³⁾ A0 = V_{IL}	Manufacturer Code ⁽⁴⁾	
Hardware					A1 - A19 = V_{IL} , A9 = V_{H} , ⁽³⁾ A0 = V_{IH}	Device Code ⁽⁴⁾	
O o (5)					A0 = V _{IL} , A1 - A19 = V _{IL}	Manufacturer Code ⁽⁴⁾	
Sonware					A0 = V _{IH} , A1 - A19 = V _{IL}	Device Code ⁽⁴⁾	

Notes: 1. X can be V_{IL} or V_{IH} .

- 2. Refer to AC Programming Waveforms.
- 3. $V_{H} = 12.0V \pm 0.5V$
- 4. Manufacturer Code: 1FH
 - Device Code: 23H (AT49F080), 27H (AT49F080T)
- 5. See details under Software Product Identification Entry/Exit..

DC Characteristics

Symbol	Parameter	Condition		Min	Max	Units
ILI	Input Load Current	$V_{IN} = 0V$ to V_{CC}		10	μΑ	
I _{LO}	Output Leakage Current	$V_{I/O} = 0V$ to V_{CC}			10	μΑ
		$\overline{CE} = V_{CC} - 0.3V$ to V_{CC}	Com.		100	μA
I _{SB1}	V _{CC} Standby Current CMOS		Ind.		300	μΑ
I _{SB2}	V _{CC} Standby Current TTL	$\overline{\text{CE}}$ = 2.0V to V _{CC}		3	mA	
I _{CC} ⁽¹⁾	V _{CC} Active Current	f = 5 MHz; I _{OUT} = 0 mA			50	mA
V _{IL}	Input Low Voltage				0.8	V
V _{IH}	Input High Voltage			2.0		V
V _{OL}	Output Low Voltage	I _{OL} = 2.1 mA			0.45	V
V _{OH1}	Output High Voltage	I _{OH} = -400 μA	2.4		V	
V _{OH2}	Output High Voltage CMOS	$I_{OH} = -100 \ \mu A; \ V_{CC} = 4.5 V$		4.2		V

Note: 1. I_{CC} in the erase mode is 90 mA.



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AC Read Characteristics

		AT49F080(T)-90		AT49F080(T)-12		AT49F0		
Symbol	Parameter	Min	Max	Min	Max	Min	Max	Units
t _{ACC}	Address to Output Delay		90		120		150	ns
t _{CE} ⁽¹⁾	CE to Output Delay		90		120		150	ns
t _{OE} ⁽²⁾	OE to Output Delay	0	40	0	50	0	70	ns
t _{DF} ⁽³⁾⁽⁴⁾	\overline{CE} or \overline{OE} to Output Float	0	25	0	30	0	40	ns
t _{OH}	Output Hold from OE, CE or Address, whichever occurred first	0		0		0		ns

AC Read Waveforms



- Notes: 1. \overline{CE} may be delayed up to t_{ACC} t_{CE} after the address transition without impact on t_{ACC} .
 - OE may be delayed up to t_{CE} t_{OE} after the falling edge of CE without impact on t_{CE} or by t_{ACC} t_{OE} after an address change without impact on t_{ACC}.
 - 3. t_{DF} is specified from \overline{OE} or \overline{CE} whichever occurs first (CL = 5 pF).
 - 4. This parameter is characterized and is not 100% tested.

Input Test Waveforms and Measurement level





 $t_R, t_F < 5 ns$

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Pin Capacitance

 $f = 1 \text{ MHz}, T = 25^{\circ}C^{(1)}$

Symbol	Тур	Мах	Units	Conditions
C _{IN}	4	6	pF	$V_{IN} = 0V$
C _{OUT}	8	12	pF	$V_{OUT} = 0V$

Note: 1. This parameter is characterized and is not 100% tested.

AC Byte Load Characteristics

Symbol	Parameter	Min	Max	Units
t _{AS} , t _{OES}	Address, OE Set-up Time	0		ns
t _{AH}	Address Hold Time	50		ns
t _{cs}	Chip Select Set-up Time	0		ns
t _{CH}	Chip Select Hold Time	0		ns
t _{WP}	Write Pulse Width (\overline{WE} or \overline{CE})	90		ns
t _{DS}	Data Set-up Time	50		ns
t _{DH} , t _{OEH}	Data, OE Hold Time	0		ns
t _{wPH}	Write Pulse Width High	90		ns

AC Byte Load Waveforms

WE Controlled



CE Controlled







Program Cycle Characteristics

Symbol	Parameter	Min	Тур	Max	Units
t _{BP}	Byte Programming Time		10	50	μs
t _{AS}	Address Set-up Time	0			ns
t _{AH}	Address Hold Time	50			ns
t _{DS}	Data Set-up Time	50			ns
t _{DH}	Data Hold Time	0			ns
t _{WP}	Write Pulse Width	90			ns
t _{WPH}	Write Pulse Width High	90			ns
t _{EC}	Erase Cycle Time			10	seconds

Program Cycle Waveforms



Chip Erase Cycle Waveforms





AT49F080(T)

Data Polling Characteristics⁽¹⁾

Symbol	Parameter	Min	Тур	Max	Units
t _{DH}	Data Hold Time	10			ns
t _{OEH}	OE Hold Time	10			ns
t _{OE}	OE to Output Delay ⁽²⁾				ns
t _{WR}	Write Recovery Time	0			ns

Notes: 1. These parameters are characterized and not 100% tested

2. See t_{OE} spec in AC Read Characteristics.

Data Polling Waveforms



Toggle Bit Characteristics⁽¹⁾

Symbol	Parameter	Min	Тур	Max	Units
t _{DH}	Data Hold Time				ns
t _{OEH}	OE Hold Time	10			ns
t _{OE}	OE to Output Delay ⁽²⁾				ns
t _{OEHP}	OE High Pulse	150			ns
t _{WR}	Write Recovery Time	0			ns

Notes: 1. These parameters are characterized and not 100% tested.

2. See t_{OE} spec in AC Read Characteristics.

Toggle Bit Waveforms⁽¹⁾⁽²⁾⁽³⁾



- Notes: 1. Toggling either \overline{OE} or \overline{CE} or both \overline{OE} and \overline{CE} will operate toggle bit. The t_{OEHP} specification must be met by the toggling input(s).
 - 2. Beginning and ending state of I/O6 will vary.
 - 3. Any address location may be used but the address should not vary.



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Software Product Identification Entry⁽¹⁾



Boot Block Lockout Feature Enable Algorithm⁽¹⁾



- Notes: 1. Data Format: I/07 I/O0 (Hex); Address Format: A14 - A0 (Hex).
 - 2. Boot block lockout feature enabled.

- Notes: 1. Data Format: I/O7 I/O0 (Hex); Address Format: A14 - A0 (Hex).
 - 2. A1 A19 = V_{IL} . Manufacture Code is read for A0 = V_{IL} ; Device Code is read for A0 = V_{IH} .
 - 3. The device does not remain in identification mode if powered down.
 - 4. The device returns to standard operation mode.
 - 5. Manufacturers Code: 1FH Device Code: 23H (AT49F080), 27H (AT49F080T)

AT49F080(T)



AT49F080 Ordering	Information
-------------------	--------------------

tacc	I _{CC} (mA)					
(ns)	Active	Standby	Ordering Code	Package	Operation Range	
90	50	0.1	AT49F080-90CC	42C2	Commercial	
			AT49F080-90RC	44R	(0° to 70°C)	
			AT49F080-90TC	40T		
	50	0.3	AT49F080-90CI	42C2	Industrial	
			AT49F080-90RI	44R	(-40° to 85°C)	
			AT49F080-90TI	40T		
120	50	0.1	AT49F080-12CC	42C2	Commercial	
			AT49F080-12RC	44R	(0° to 70°C)	
			AT49F080-12TC	40T		
	50	0.3	AT49F080-12CI	42C2	Industrial	
			AT49F080-12RI	44R	(-40° to 85°C)	
			AT49F080-12TI	40T		
150	50	0.1	AT49F080-15CC	42C2	Commercial	
			AT49F080-15RC	44R	(0° to 70°C)	
			AT49F080-15TC	40T		
	50	0.3	AT49F080-15TI	42C2	Industrial	
			AT49F080-15TI	44R	(-40° to 85°C)	
			AT49F080-15TI	40T		

(continued)

	Package Type
42C2	42-Ball, Plastic Chip-Size Ball Grid Array Package (CBGA) 8 x 14 mm
44R	44-Lead, 0.525" Wide, Plastic Gull Wing Small Outline Package (SOIC/SOP)
40T	40-Lead, Thin Small Outline Package (TSOP)





AT49F080T Ordering Information

tacc	I _{CC} (mA)					
(ns)	Active	Standby	Ordering Code	Package	Operation Range	
90	50	0.1	AT49F080T-90CC	42C2	Commercial	
			AT49F080T-90RC	44R	(0° to 70°C)	
			AT49F080T-90TC	40T		
	50	0.3	AT49F080T-90CI	42C2	Industrial	
			AT49F080T-90RI	44R	(-40° to 85°C)	
			AT49F080T-90TI	40T		
120	50	0.1	AT49F080T-12CC	42C2	Commercial	
			AT49F080T-12RC	44R	(0° to 70°C)	
			AT49F080T-12TC	40T		
	50	0.3	AT49F080T-12CI	42C2	Industrial	
			AT49F080T-12RI	44R	(-40° to 85°C)	
			AT49F080T-12TI	40T		
150	50	0.1	AT49F080T-15CC	42C2	Commercial	
			AT49F080T-15RC	44R	(0° to 70°C)	
			AT49F080T-15TC	40T		
	50	0.3	AT49F080T-15CI	42C2	Industrial	
			AT49F080T-15RI	44R	(-40° to 85°C)	
			AT49F080T-15TI	40T		

Package Type			
42C2	42-Ball, Plastic Chip-Size Ball Grid Array Package (CBGA) 8 x 14 mm		
44R	44-Lead, 0.525" Wide, Plastic Gull Wing Small Outline Package (SOIC/SOP)		
40T	40-Lead, Thin Small Outline Package (TSOP)		

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Packaging Information













Atmel Headquarters

Corporate Headquarters 2325 Orchard Parkway San Jose, CA 95131 TEL (408) 441-0311

FAX (408) 487-2600

Europe

Atmel U.K., Ltd. Coliseum Business Centre Riverside Way Camberley, Surrey GU15 3YL England TEL (44) 1276-686677 FAX (44) 1276-686697

Asia

Atmel Asia, Ltd. Room 1219 Chinachem Golden Plaza 77 Mody Road Tsimshatsui East Kowloon, Hong Kong TEL (852) 27219778 FAX (852) 27221369

Japan

Atmel Japan K.K. Tonetsu Shinkawa Bldg., 9F 1-24-8 Shinkawa Chuo-ku, Tokyo 104-0033 Japan TEL (81) 3-3523-3551 FAX (81) 3-3523-7581

Atmel Operations

Atmel Colorado Springs

1150 E. Cheyenne Mtn. Blvd. Colorado Springs, CO 80906 TEL (719) 576-3300 FAX (719) 540-1759

Atmel Rousset

Zone Industrielle 13106 Rousset Cedex, France TEL (33) 4 42 53 60 00 FAX (33) 4 42 53 60 01

Fax-on-Demand

North America: 1-(800) 292-8635 International: 1-(408) 441-0732

e-mail literature@atmel.com

Web Site http://www.atmel.com

BBS 1-(408) 436-4309

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